

## **AMENDMENTS TO THE CLAIMS**

1-9. (Canceled)

10. (New) In a method of forming heat-resistant raised print, comprising the following steps in the order named:

- a) applying a wet inked print to a substrate;
  - b) applying a radiation-curable acrylated polymer powder composition, including plasticizer, to the wet inked print on the substrate, whereby the powder composition adheres to the wet inked print;
  - c) heating the powder to melt temperature, whereby the powder composition flows and fuses with the wet inked print to form a raised radiation-curable melt; and
  - d) irradiating the raised radiation-curable melt whereby the raised radiation-curable melt polymerizes and forms a heat-resistant raised radiation-curable melt on the substrate,
- the improvement which comprises employing, as a plasticizer, a radiation-sensitive, semi-crystalline polyester containing (meth)acryloyl groups.

11. (New) The method according to claim 10, wherein said radiation-curable polymer powder composition further contains (meth)acrylated epoxy oligomers and (meth)acrylated polyester oligomers.

12. (New) The method according to claim 11, wherein the (meth)acrylated epoxy oligomers are present at 25 to 75 wt% and the (meth)acrylated polyester oligomers are present at 75 to 25 wt%.

13. (New) The method according to claim 12, wherein the (meth)acrylated epoxy oligomers are present at 50 wt% and the (meth)acrylated polyester oligomers are present at 50 wt%.

14. (New) The method according to claim 10, wherein said radiation-curable acrylated polymer powder composition further comprises one or more members selected from the group consisting of photo-initiators, flow control agents, appearance agents and degassing agents.

15. (New) The method according to claim 10, wherein the radiation-sensitive plasticizer is present in an amount of from about 1 to about 20 wt%.

16. (New) The method according to claim 10, wherein said irradiating is performed with ultraviolet radiation.

17. (New) The method according to claim 10, wherein said substrate comprises paper.

18. (New) The method according to claim 17, wherein said paper is stationary, greeting cards or business cards.

19. (New) The method according to claim 10, wherein step c) is performed at a temperature below 150°C.

20. (New) The method according to claim 19, wherein said temperature is from about 50°C to about 80°C.